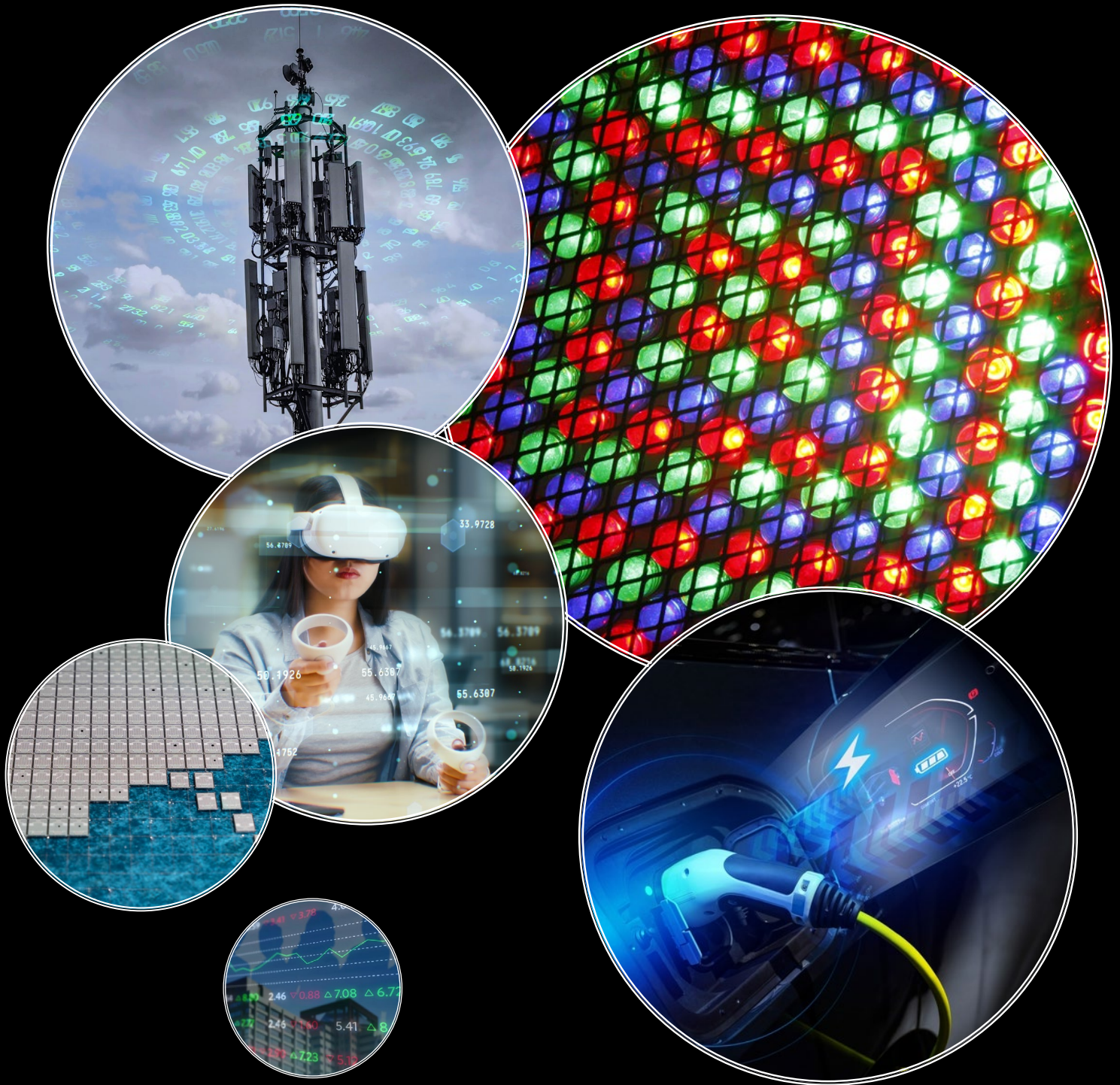




COMPOUND SEMICONDUCTOR

CONNECTING THE COMPOUND SEMICONDUCTOR COMMUNITY



MEDIA PACK 2026

compoundsemiconductor.net

Editor's **viewpoint**

COMPOUND SEMICONDUCTOR continues to hold a well-earned reputation for its great delivery of timely news, insightful interviews and detailed reports on advances in technology. Via the magazine and website, this broad platform provides a trusted, balanced source for following the biggest developments, including: the growth of the power electronics industry, critical to cutting carbon footprints; the expanding portfolio of lasers; the LED industry, now entering a new phase through the development of microLEDs; and RF devices, critical to mobile communications.

The compound semiconductor community is continually renewed by the efforts of its pioneers. Throughout the next year and beyond, much coverage will be devoted to the development of ultra-wide bandgap materials, such as diamond, AlGa_N and Ga₂O₃; power electronics based on SiC, GaN and Ga₂O₃; RF devices for 5G and 6G; breakthroughs in photonics, including new VCSEL designs; and advances in power, efficiency and spectral range in the RF.

By reporting on the biggest stories from all over the world for 30 years, Compound Semiconductor has a strongly established global presence and readership.

The clear, elegant website delivers daily news, brought together and dispatched to in-boxes in a timely fashion in the form of News alerts, distributed twice a week.

Features detailing breakthroughs in chip and material technologies lie at the heart of the magazine, which also provides in-depth interviews, conference reports, and exclusive opinion pieces and research stories.

Within these editions, provided in print and various digital forms, plus the website and News alert, are a multitude of options for companies positioned everywhere in the value chain to promote their exceptional products and services. Read on to discover what Compound Semiconductor can do for you in the coming year.





productoverview

THE COMPOUND SEMICONDUCTOR PORTFOLIO INCLUDES:

- Compound Semiconductor magazine: Global circulation – compoundsemiconductor.net
- China magazine: Simplified Mandarin – compoundsemiconductorchina.net
- CS International: Dedicated international conference – cs-international.net
- Twice weekly E-Mail news alerts: Global broadcast



化合物半导体
COMPOUND SEMICONDUCTOR CHINA

CS INTERNATIONAL
CONFERENCE

ANGELTECH

editorial calendar

2026

EACH ISSUE will carry news, features and research from the full spectrum of the compound semiconductor community.

The magazine and its associated website deliver comprehensive coverage of the compound semiconductor industry, from the business of making LEDs, amplifiers, lasers and power chips to development of a vast array of new devices.

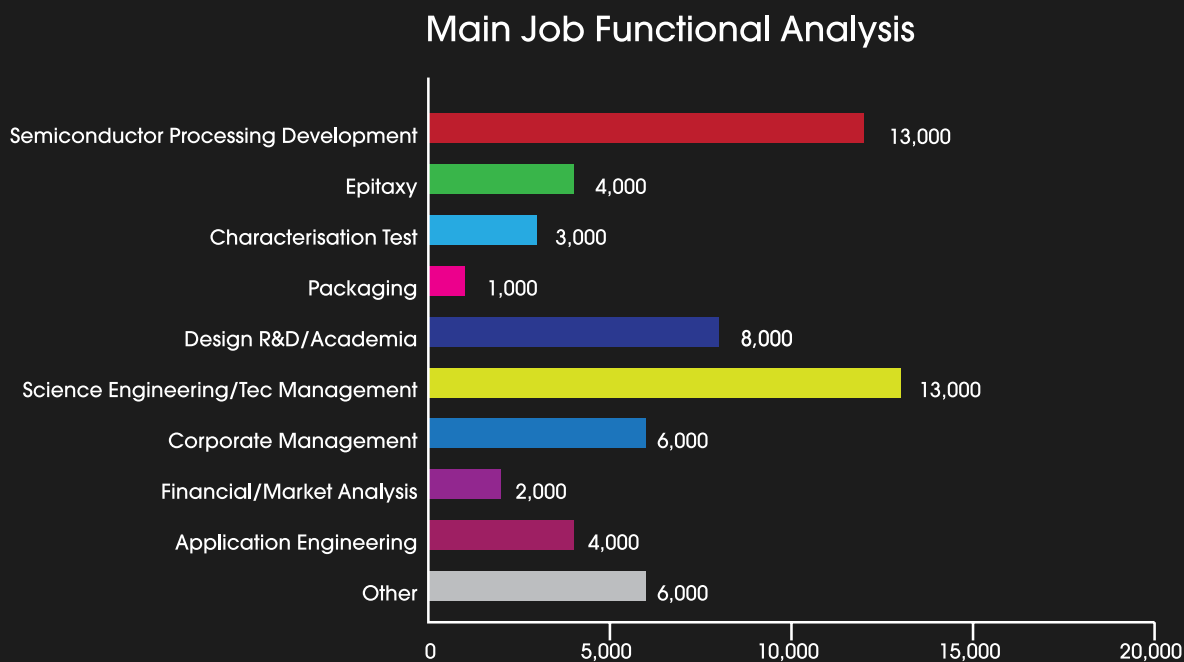
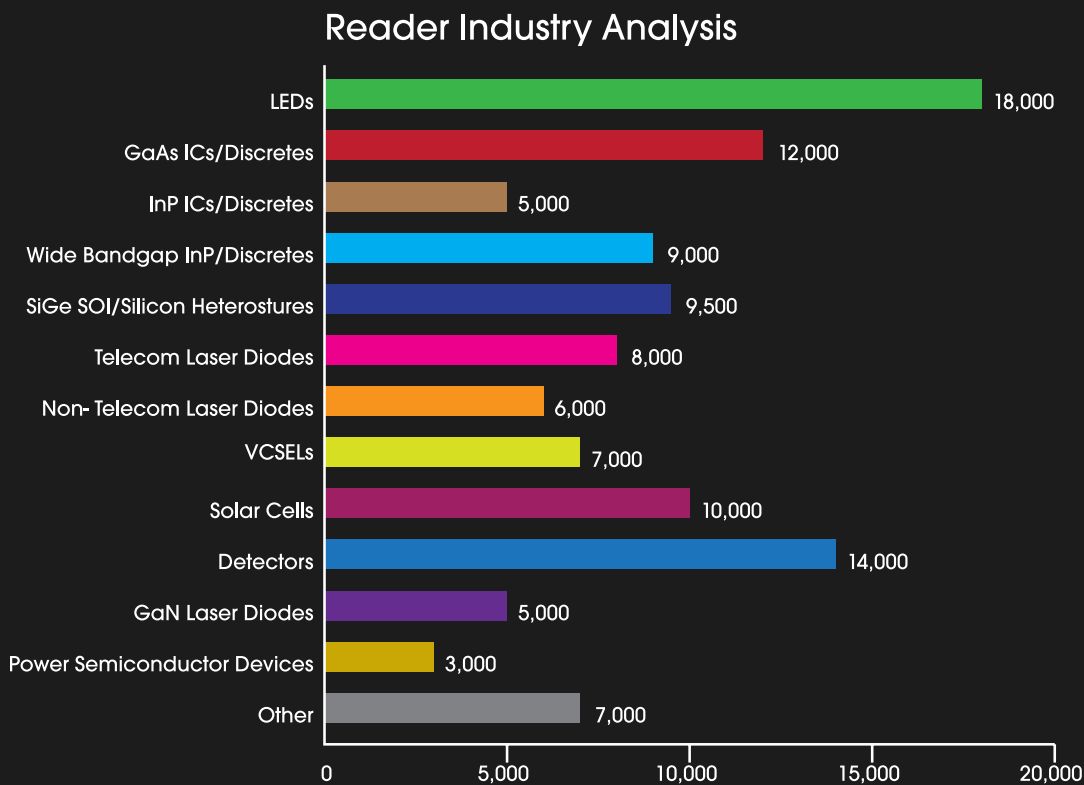
Compound Semiconductor magazine is also distributed in advance of various industry events throughout the year.

ISSUE	COPY DATE	PRIMARY THEME	SECONDARY THEME	PRE-SHOW DISTRIBUTION
Issue 1 Ad Copy Mailed	20-01-26 05-02-26	Heterogenous Integration	SiC	OFC
Issue 2 Ad Copy Mailed	17-02-26 06-03-26	GaN Power Devices	Simulation	CS International
Issue 3 Ad Copy Mailed	27-03-26 13-04-26	Epitaxy	Back-end Processing	CS Mantech
Issue 4 Ad Copy Mailed	07-05-26 21-05-26	RF Devices	Stocks & Shares	-
Issue 5 Ad Copy Mailed	11-06-26 25-06-26	Lasers	Device Reliability	-
Issue 6 Ad Copy Mailed	24-07-26 07-08-26	VCSELs	MOCVD	ICSCRM + ECOC
Issue 7 Ad Copy Mailed	04-09-26 18-09-26	Optoelectronics	Etching Technologies	Semicon West
Issue 8 Ad Copy Mailed	16-10-26 30-10-26	LEDs	Metrology	Semicon Europa + IEDM
Issue 9 Ad Copy Mailed	13-11-26 27-11-26	Gallium Oxide	MBE	-

magazinecirculationanalysis

A TRULY GLOBAL AUDIENCE

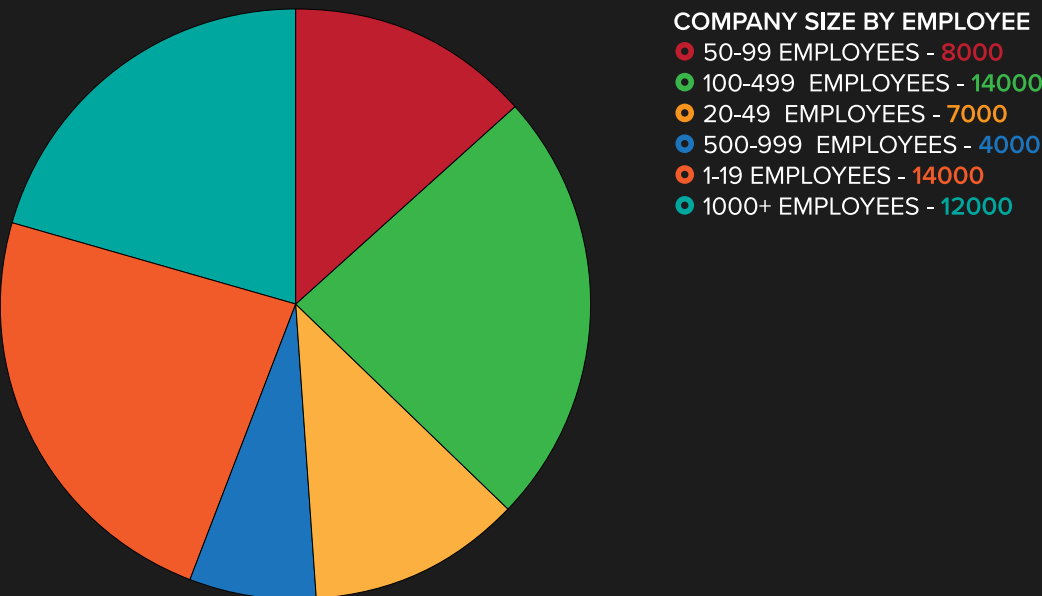
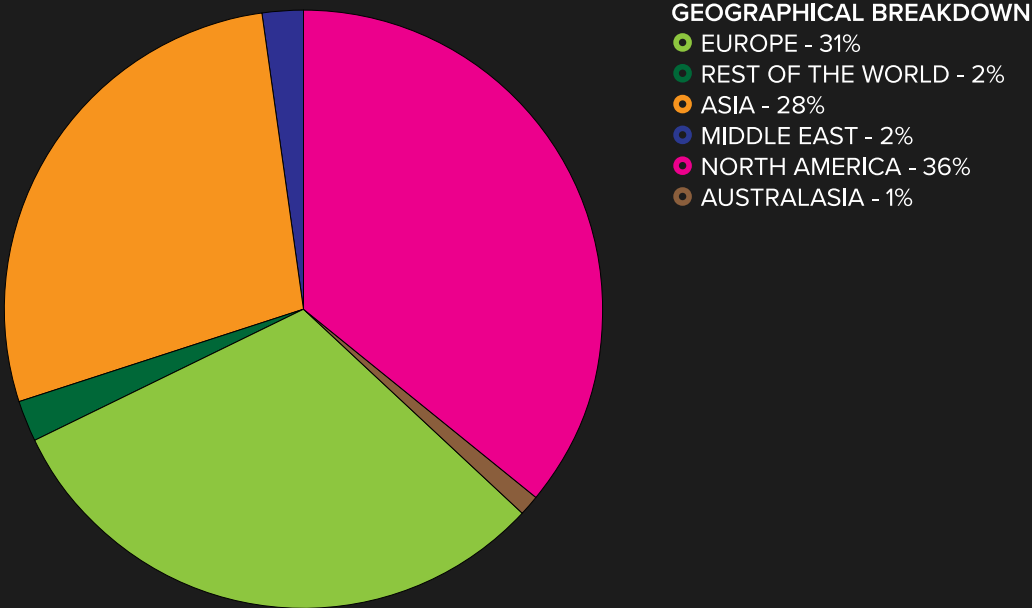
Compound Semiconductor magazine (alongside compoundsemiconductor.net) is the primary information resource for professionals working with compound semiconductor materials and devices. Each issue of the magazine is distributed in print and digitally to over 60,000 professionals worldwide. Compound Semiconductor magazine is also distributed at various global industry events throughout the year.



magazine**circulation**analysis

A TRULY GLOBAL AUDIENCE

Our global and qualified audience of buyers is the largest and most diverse served by any compound semiconductor focused magazine. Our readers rely on our strategic articles and reviews to help make decisions that will influence supplier choices.





displayrates



Size	9x	4x	1x
Full Page	6,287	6,571	6,880
Half Page	4,334	4,454	4,807
Half Island	4,586	4,775	5,166
Third Vertical	2,741	2,961	3,295
Quarter Page	2,142	2,325	2,514
Inside Cover	6,601	6,890	7,244
Outside Cover	6,915	7,288	7,570

Contact: Ranjodh Shergill, Sales Executive
T: +44 (0)2476 718 975 E: Ranjodh.Shergill@angelbc.com

STANDOUT from the Crowd

Front Cover Promotion Package

THE FRONT COVER of Compound Semiconductor Magazine is the most prestigious position in the magazine. It allows for an image and a technology story connected to your company to be showcased in front of a global audience. Compound Semiconductor Magazine is distributed to over 60,000.

WHAT DO YOU GET?

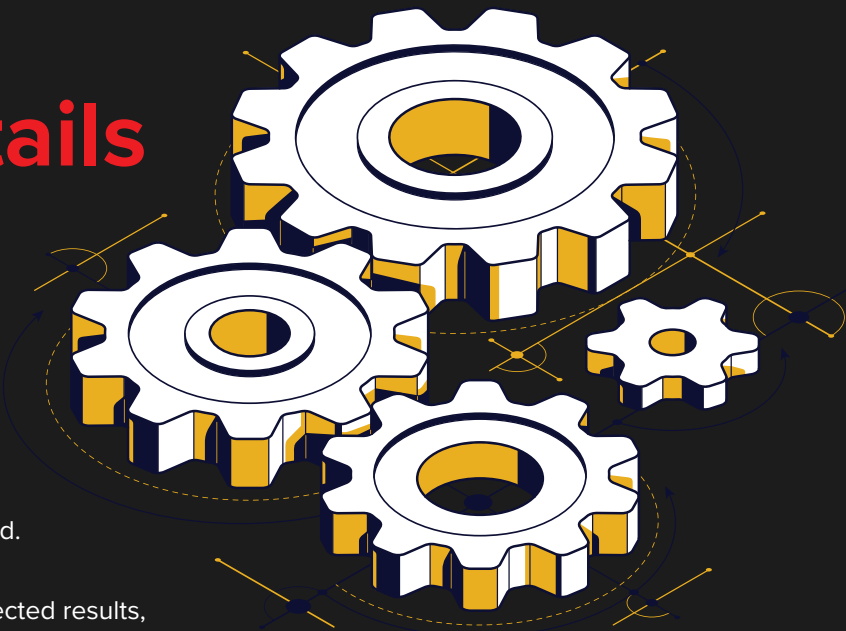
- Cover image with your branding
- 4 - 5 pages of editorial within magazine
- Full page advertisement
- Magazine hosted on compoundsemiconductor.net for six weeks
- 30 copies for promotion
- PDF of your cover and article for web promotion

Price on Application

Contact: Ranjodh Shergill **T:** +44 (0)2476 718 975 **E:** ranjodh.shergill@angelbc.com



mechanicaldetails



FILE FORMAT

High Resolution PDF.

- Files must be CMYK, images should be high resolution 300 dpi, with ALL fonts embedded.
- Files must contain printers marks and show bleed.

Any file supplied non-CMYK, may print with unexpected results, due to possible colour shifts during CMYK conversion.

DELIVERY METHODS

Email: mitch.gaynor@angelbc.com

or use: wettransfer.com / mailbigfiles.com or any other method

If you require any assistance please contact:

Mitch Gaynor

Design & Production Manager

T: +44 (0)1923 690 214 or **E:** mitch.gaynor@angelbc.com

Advertisement Size	Trim Size (mm) (w) Width x (h) Height	Bleed (+3mm)
A - DPS (Double Page Spread)	420 x 297	426 x 303
B - Full Page A4	210 x 297	216 x 303
C - 1/2 Page Horizontal	177 x 130	-
D - Island (On request)	121 x 186	-
E - 1/3 Page Vertical	55 x 237	-
F - 1/3 Page Horizontal	177 x 75	-
G - 1/4 Page Horizontal	177 x 58	-
Corporate Partnership	55 x 27	-



Disclaimer: Whilst every effort is made to ensure that advertisements are produced to the highest standards, Angel Business Communications will not accept responsibility for the reproduction of adverts that have not been supplied to our specification

website **advertising** options

LEADER BOARD

DURATION: 1 MONTH

€3,000

MAIN DISPLAY SIZE:

1109 x 92 (Please supply as 1281 x 105)

RECTANGULAR BANNER

DURATION: 1 MONTH

€1,800

MAIN DISPLAY SIZE:

475 x 238 (Please supply as 700 x 350)

SKYSCRAPER

DURATION: 1 MONTH

€1,320

MAIN DISPLAY SIZE:

158 x 389 (Please supply as 335 x 825*)

SQUARE BANNER

DURATION: 1 MONTH

€1,600

MAIN DISPLAY SIZE:

158 x 158 (Please supply as 335 x 335)

NEWS SECTION BANNER

DURATION: 1 MONTH

€1,320

MAIN DISPLAY SIZE:

426 x 90 (Please supply as 888 x 188)

VIDEO

DURATION: 1 MONTH

€1,320

MAIN DISPLAY SIZE:

340 x 170 (Please supply as 1280 x 720)

NATIVE BANNER

DURATION: 1 MONTH

€2,400

MAIN DISPLAY SIZE:

600 x 300 (Please supply as 1000 x 500)

CORPORATE PARTNERS

DURATION: 12 MONTHS

€2,100

MAIN DISPLAY SIZE:

Landscape logos will appear larger than portrait logos

FLOOR BANNER

DURATION: 1 MONTH

€2,400

MAIN DISPLAY SIZE:

1481 x 122 (Please supply as 1568 x 130)

The screenshot displays the Compound Semiconductor website with various advertising placements. At the top, there's a navigation bar with links like HOME, NEWS, MAGAZINE, VIDEOS, BUYER'S GUIDE, etc. Below this, the 'LEADERBOARD' section is highlighted in green. The main content area is divided into several sections: 'Industry News', 'Company News', 'Interviews', 'Technical Insight', 'Vendor View', and 'Lab And Fab News'. Each section contains news items with images and headlines. To the right of the main content, there are several rectangular and square banners, some labeled 'RECTANGLE', 'SKYSCRAPER', 'SQUARE', and 'NEWS SECTION BANNER'. Below the main content, there's a section for 'Most recent issues of Compound Semiconductor Magazine' with three magazine covers displayed. To the right of the magazines, there are three yellow rectangular banners labeled 'VIDEO'. At the bottom of the page, there's a 'Corporate Partners' section with a large grid of green squares and the text 'CORPORATE PARTNERS' in large blue letters. Below this, there's a footer with navigation links, a list of magazines, a list of conferences, and a list of awards. At the very bottom, there's a purple banner labeled 'FLOOR BANNER'.

All banners and logos must be supplied as GIF, JPG with "alt" text and a URL to which to link the banner or logo. Advertisers must warrant that they have tested adverts for technical stability on Internet Explorer, Firefox, Opera, Safari and Google Chrome browsers prior to supply. For the purposes of these guidelines, stability is defined as not causing error messages, dialogue windows, excessive CPU usage, browser crashes or system crashes.

Positions subject to availability

THE COMPOUND SEMICONDUCTOR EMAIL NEWS ALERTS deliver the latest industry news direct into the inboxes of our subscribers, and provide our news alert sponsors a fantastic opportunity to get their message seen by over 60,000 industry professionals.

- Sponsor's message (up to 100 words)
- 728 x 90 banner
- Cost: €1.800

Would you like your company, products or services to reach over 60,000 industry professionals?

Price €2000

[illegible]

11 compoundsemiconductor.net



CS **ZOOM** interview

- The 15 or 30 min interview allows for multiple topics to be addressed. As well as promoted through our platforms, it also is a useful asset for your company
- Moderated by the editor Richard Stevenson
- Questions prepared and shared in advance
- An opportunity to edit file(s) in advance
- This video would be a useful asset for any company to use on their website and social media platforms
- This interview would be publicised for four weeks through all our mediums including:
 - On two CS Newsletters
 - Promoted once through our social media platforms

Cost per **ZOOM** interview

- 15 mins **€995** (This allows for discussion based around a single issue or product announcement)
- 30 mins **€1800** (This allows for a deeper dive into a particular topic)



corporate **partnership** program

WHAT YOU GET?

- **PRINT:** A Corporate Partnership entry in 9 issues of CS Magazine (Size W x H) 55mm x 27mm
- **WEBSITE:** A Corporate Partnership box (size 160 x 60 pixel) under Corporate Partners section on Compound Semiconductor homepage, compoundsemiconductor.net for 12 months linking to your website
- Enhance directory listing within CS Buyers Guide
- **NEWSLETTER:** One sponsorship of CS E-News Alert with a 728 x 90 pixel banner + text (100 words)
- A banner (size 160 x 60) on the CS E- Newsletter, linking to your company home page

PROGRAM 1

Price: €2500

Promoting your products or your brand through a Corporate Partnership Program in is an economical way to generate interest and drive prospects.

Your message will reach over 60,000 professionals worldwide through 3 different mediums of magazine, website and newsletter which creates maximum visibility.

PROGRAM 2

Price: €3680

Corporate Partnership 2 will include all Program 1 benefits PLUS the following:

- 1 x half page advertisement in classified section
- 1 x half page Vendor View feature which includes 150 words and a photograph of product or program.

CS WEBINAR

Dedicated webinars for the compound semiconductor industry

- Based around a hot topic for your company
- 60-minute ZOOM webinar
- Moderated by an editor
- Can include 2 speakers
- Questions prepared and shared in advance

This event would be publicised for 8 weeks:

- Banner on Compound Semiconductor website
- 4x weekly dedicated HTMLs
- 4x news pieces on weekly e-newsletters
- Promoted through our social media platforms
- Available on-demand for 6 months
- All registered attendees' details provided

Package cost: €7500



CONTACT:

Jackie Cannon

jackie.cannon@angelbc.com



COMPOUND SEMI SOCIAL MEDIA

The Compound Semiconductor (CS) Social Media Package



THE COMPOUND SEMICONDUCTOR (CS) SOCIAL MEDIA PACKAGE

Incorporating CS social media posts into your marketing plan is crucial for several compelling reasons. Here are the best reasons for using CS social media in your strategy.

1. Increased Brand Visibility

By maintaining an active presence on CS social media you can significantly increase the visibility of your company to relevant audience of buyers and specifiers.

2. Targeted Audience Engagement

Social media allows for precise targeting. This ensures your content reaches the most relevant audience, such as datacentre managers, decision-makers, and industry influencers who are interested in your company solutions.

3. Showcasing Expertise and Innovation

Regularly sharing updates, articles, case studies, and insights about your data centre solutions demonstrates your industry expertise and positions your brand as a thought leader. Highlighting your technological advancements and innovative solutions can attract interest from potential customers.

4. Driving Website Traffic and Lead Generation

Posts that include links to your website, blog, or specific landing pages can drive significant traffic and generate high-quality leads.

5. Customer Interaction and Feedback

CS Social media provides a platform for direct communication

with your customers. You can quickly address inquiries, gather feedback, and engage in meaningful conversations, which helps in building strong customer relationships and trust.

Incorporating social media posts into your marketing plan to Compound Semiconductor leverages these benefits to enhance your brand's presence, engage with your audience, and drive business growth.

Packages to reach 6113 (July 2024) subscribers:

- 1 post (to LinkedIn and X) €500
- 2 posts (to LinkedIn and X) €750
- 3 posts (to LinkedIn and X) €1000



Compound Semiconductor Magazine &
CS International Conference



@compoundsemi

Contact:

Ranjodh Shergill
ranjodh.shergill@angelbc.com
+44 (0)2476 718 970

contactus

SALES

B2B Event & Media Sales Executive

Ranjodh Shergill

E: ranjodh.shergill@angelbc.com

T: 44 (0)2476 718 975

EDITORIAL

Editor

Dr. Richard Stevenson

E: richard.stevenson@angelbc.com

T: +44 (0)1291 629 640

News Editor

Christine Evans-Pughe

T: chrise-p@dircon.co.uk

PRODUCTION

Design & Production Manager

Mitch Gaynor

E: mitch.gaynor@angelbc.com

T: +44 (0)1923 690 214

Marketing Manager

Jane Bunclark

E: jane.bunclark@angelbc.com

T: +44 (0) 2476 718 970

Publisher

Jackie Cannon

E: jackie.cannon@angelbc.com

T: +44 (0)1923 690 205

CEO

Sukhi Bhadal

E: sukhi.bhadal@angelbc.com

T: +44 (0)2476 718 970

CTO

Scott Adams

E: scott.adams@angelbc.com

T: +44 (0)2476 718 973



Unit 6, Bow Court, Fletchworth Gate, Burnsall Road, Coventry, CV5 6SP, UK.

T: +44 (0)2476 718 970 **E:** info@angelbc.com **W:** angelbc.com

